

| TITLE |  | PRODUCT SPECIFICATIONS |  |
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| 6-2. Mechanical performance |  |  |  |
|  | Items | Test conditions | Criteria |
| 6.2.1 | Actuating <br> force | Actuating force should be applied horizontal and vertical to the stem as shown in Fig1, Fig2. When actuate the stem, force should be applied gradually. | Push on : 250 $\pm 80 \mathrm{gf}$ <br> Tilting : 110 $\pm 70 \mathrm{~g}$ |
| 6.2.2 | Stroke | The travel distance should be measured to the stem as shown in Fig1(Push on) and Fig2(Tilting). When actuate the stem force should be applied gradually. | Push on : $0.2 \pm 0.1 \mathrm{~mm}$ Tilting : $0.5 \pm 0.2 \mathrm{~mm}$ |
| 6.2.3 | Return force | The force of the stem to return to its free position shall be measured after actuating force is applied as shown in Fig1, Fig2. | Push on : 50gf Min <br> Tilting : 20gf Min |
| 6.2.4 | Stop strength | A static load of 3 Kgf is applied to the horizontal and vertical direction as shown in Fig1 and 2 for a period of 60 seconds. | There shall be no sign of damage mechanically and electrically. |
| 6.2 .5 | Stem strength | A static load is applied to the pull direction there should be no damages. | 500gf Min |
| Really, an electrical signal processing be made $5^{\circ} \sim 9^{\circ}$ tilting degree even under the Maximum Tilting $12^{\circ}$ |  |  |  |
| 6-3. Environmental performance |  |  |  |
|  | Items | Test conditions | Criteria |
| 6.3.1 | Resistance to low Temperature | When test being done under these condition, it should be tested after one hour leave in normal temperature and humidity. <br> (1)Temperature : $-40 \pm 2^{\circ} \mathrm{C}$ <br> (2)Time : 96 hours <br> (3)Water drops shall be removed | Item 6-1 <br> Item 6-2-1 <br> Item 6-2-2 <br> Item 6-2-3 |
| 6.3.2 | Heat resistance | When test being done under these condition, it should be tested after one hour leave in normal temperature and humidity. <br> (1)Temperature : $+85 \pm 2^{\circ} \mathrm{C}$ <br> (2)Time : 96 hours | Item 6-1 <br> Item 6-2-1 <br> Item 6-2-2 <br> Item 6-2-3 |
| 6.3.3 | Moisture resistance | When test being done under these condition, it should be tested after one hour leave in normal temperature and humidity. <br> (1)Temperature : $+60 \pm 2^{\circ} \mathrm{C}$ <br> (2)Relative humidity : 90 to $95 \% \mathrm{RH}$ <br> (3)Time : 96 hours | Item 6-1 <br> Item 6-2-1 <br> Item 6-2-2 <br> Item 6-2-3 |



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3. Automatic soldering condition
3.1 Soldering
3.1.1 Temperature : less than $260^{\circ} \mathrm{C}$
3.1.2 Time : Continuous dipping duration shall not exceed 10 seconds.
3.1.3 Premissible soldering times: less than twice
( The second soldering would be conducted after the temperature goes down to a normal temperature )
3.2 Preheat
3.2.1 Temperature : less than $100^{\circ} \mathrm{C}$
( Circumferential temperature of the printed circuit board )
3.2.2 Time: less than 45 second
3.3 Flux streaming
: flux streaming shall be controlled so that it shall not swell beyond the printed circuit board where components are installed.
3.4 Other precautions
3.4.1 Flux shall not be applied to the switch terminals and the part mounting surface of the printed circuit board before soldering.
3.4.2 Do not wash the switch after soldering.

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Caution

1. When terminals are exposed to mechanical stress during soldering, it may cause degradation in deformation and electrical property.
2. Through-hole PC board, or a PC board thickness other than the recommendation may cause larger heat stress. Prior verification is highly recommended.
3. In prior to the 2 nd soldering switch shall be stable with normal temperature. It may cause deformation of switch, loose terminals, terminal removed from PCB, and / or degradation of electric property.
4. Verify samples with actual mass production conditions.
5. The products are designed and manufactured for direct current resistance. Individual consultation is recommended for use of other resistances such as inductive (L) or capacitive (C).
6. The sizes of holes and patterns on a PC board for mounting a switch, be as per the recommended dimensions in the product drawings.
7. This switch is designed for manually operated units. Must not use this switch for a mechanical detection unit. For detection purposes, please use our detection switch.
8. The switch will be break if impact force or a greater stress than that specified is applied. Take great care not to let the switch be subject to greater stress than specified.
9. Do not apply a force from the side of the stem
10. Be sure to push the center of switch for "without-stem" type. Extreme care is required for a hinge structure type. as the activation point may shift when it is pressed down.
11. The circuit setting (software setting) shall be ensured for error-free operations, caused by bounce and chattering as specified by each model of the switches.
12. Prior verification is needed to ensure that no corrosive gas-generating components are used near our switch. It may give negative influence such as contact failure.
13. Contact resistance of a carbon contact type may very depending on push force. Confirm that it functions sufficiently in using TACT switch with a voltage divider circuit.
14. Be aware of dust intrusion into a non dust-proof TACT switch.
15. Storage
(1) Storage the products as delivered, at a normal temperature and humidity, without direct sunshine and corrosive gas ambient. Use them at an earliest possible timing, not later than six months upon receipt.
(2) After breaking the seal, keep the products in a plastic bag to prevent out ambient air, store them in the same environment as above, and use all as soon as possible.
(3) Do not stack too many switches.
(4) Store the key switches in released position.
16. All specification can be changed to improve performance without any notice.

